

JUL 28 2006

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of: BAYAN et al.

Attorney Docket No.:

Application No.: 10/789,258

NSC1P295/P05886

Filed: February 26, 2004

Examiner: DOAN, Theresa T.

Group: 2814

Title: DIE ATTACH PAD FOR USE IN
SEMICONDUCTOR MANUFACTURING AND
METHOD OF MAKING SAME

Confirmation No.: 9477

CERTIFICATE OF FACSIMILE TRANSMISSION

I hereby certify that this correspondence is being transmitted by facsimile to fax number 571-273-8300 to the U.S. Patent and Trademark Office on July 28, 2006.

Signed: _____

Sue Funchess

AMENDMENT BMail Stop RCE
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Examiner Doan:

In response to the Final Office Action dated May 31, 2006, please amend the above-identified patent application as follows:

Amendments to the Claims are reflected in the listing of claims which begin on page 2 of this paper.

Remarks/Arguments begin on page 5 of this paper.